Features

- Fast Read Access Time 45 ns
- Low-Power CMOS Operation
 - 100 μA Max Standby
 - 20 mA Max Active at 5 MHz
- JEDEC Standard Packages
 - 28-lead PDIP
 - 32-lead PLCC
 - 28-lead TSOP and SOIC
- 5V ± 10% Supply
- High Reliability CMOS Technology
 - 2,000V ESD Protection
 - 200 mA Latchup Immunity
- Rapid Programming Algorithm 100 µs/Byte (Typical)
- CMOS and TTL Compatible Inputs and Outputs
- Integrated Product Identification Code
- Industrial and Automotive Temperature Ranges
- Green (Pb/Halide-free) Packaging Option

1. Description

The AT27C256R is a low-power, high-performance 262,144-bit one-time programmable read-only memory (OTP EPROM) organized 32K by 8 bits. It requires only one 5V power supply in normal read mode operation. Any byte can be accessed in less than 45 ns, eliminating the need for speed reducing WAIT states on high-performance microprocessor systems.

Atmel's scaled CMOS technology provides low-active power consumption, and fast programming. Power consumption is typically only 8 mA in Active Mode and less than $10~\mu A$ in Standby.

The AT27C256R is available in a choice of industry-standard JEDEC-approved one time programmable (OTP) plastic DIP, PLCC, SOIC, and TSOP packages. All devices feature two-line control ($\overline{\text{CE}}$, $\overline{\text{OE}}$) to give designers the flexibility to prevent bus contention.

With 32K byte storage capability, the AT27C256R allows firmware to be stored reliably and to be accessed by the system without the delays of mass storage media.

Atmel's AT27C256R has additional features to ensure high quality and efficient production use. The Rapid Programming Algorithm reduces the time required to program the part and guarantees reliable programming. Programming time is typically only 100 μ s/byte. The Integrated Product Identification Code electronically identifies the device and manufacturer. This feature is used by industry-standard programming equipment to select the proper programming algorithms and voltages.



256K (32K x 8) OTP EPROM

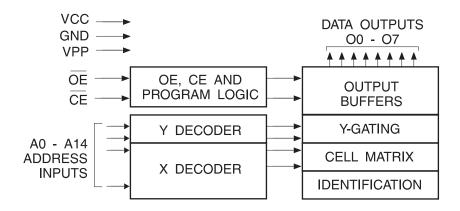
AT27C256R



3. System Considerations

Switching between active and standby conditions via the Chip Enable pin may produce transient voltage excursions. Unless accommodated by the system design, these transients may exceed datasheet limits, resulting in device non-conformance. At a minimum, a 0.1 μ F high frequency, low inherent inductance, ceramic capacitor should be utilized for each device. This capacitor should be connected between the V_{CC} and Ground terminals of the device, as close to the device as possible. Additionally, to stabilize the supply voltage level on printed circuit boards with large EPROM arrays, a 4.7 μ F bulk electrolytic capacitor should be utilized, again connected between the V_{CC} and Ground terminals. This capacitor should be positioned as close as possible to the point where the power supply is connected to the array.

4. Block Diagram



5. Absolute Maximum Ratings*

| Temperature Under Bias55°C to +125°C |
|---|
| Storage Temperature65°C to +150°C |
| Voltage on Any Pin with Respect to Ground2.0V to +7.0V ⁽¹⁾ |
| Voltage on A9 with Respect to Ground2.0V to +14.0V ⁽¹⁾ |
| V _{PP} Supply Voltage with Respect to Ground2.0V to +14.0V ⁽¹⁾ |

*NOTICE:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note: 1. Minimum voltage is -0.6V DC which may undershoot to -2.0V for pulses of less than 20 ns. Maximum output pin voltage is $V_{CC} + 0.75V$ dc which may overshoot to +7.0 volts for pulses of less than 20 ns.





Operating Modes 6.

| Mode/Pin | CE | ŌĒ | Ai | V _{PP} | Outputs |
|---------------------------------------|------------------|------------------|---|-----------------|---------------------|
| Read | V _{IL} | V _{IL} | Ai | V _{CC} | D _{OUT} |
| Output Disable | V _{IL} | V _{IH} | X ⁽¹⁾ | V_{CC} | High Z |
| Standby | V _{IH} | X ⁽¹⁾ | X ⁽¹⁾ | V_{CC} | High Z |
| Rapid Program ⁽²⁾ | V _{IL} | V _{IH} | Ai | V_{PP} | D _{IN} |
| PGM Verify ⁽²⁾ | X ⁽¹⁾ | V _{IL} | Ai | V _{PP} | D _{OUT} |
| Optional PGM Verify ⁽²⁾ | V _{IL} | V _{IL} | Ai | V_{CC} | D _{OUT} |
| PGM Inhibit ⁽²⁾ | V _{IH} | V _{IH} | X ⁽¹⁾ | V_{PP} | High Z |
| Product Identification ⁽⁴⁾ | V _{IL} | V _{IL} | $A9 = V_{H}^{(3)}$ $A0 = V_{IH} \text{ or } V_{IL}$ $A1 - A14 = V_{IL}$ | V_{CC} | Identification Code |

- Notes: 1. X can be V_{IL} or V_{IH} .
 - 2. Refer to Programming Characteristics.
 - 3. $V_H = 12.0 \pm 0.5 V$.
 - 4. Two identifier bytes may be selected. All Ai inputs are held low (V_{IL}) , except A9 which is set to V_H and A0 which is toggled low (V_{IL}) to select the Manufacturer's Identification byte and high (V_{IH}) to select the Device Code byte.

DC and AC Operating Conditions for Read Operation 7.

| | | AT270 | AT27C256R | | |
|------------------------|-------|----------------|-----------------|--|--|
| | | -45 | -70 | | |
| Operating Temp. (Case) | Ind. | -40° C - 85° C | -40° C - 85° C | | |
| | Auto. | | -40° C - 125° C | | |
| V _{CC} Supply | | 5V ± 10% | 5V ± 10% | | |

DC and Operating Characteristics for Read Operation

| Symbol | Parameter | Condition | | Min | Max | Units |
|---------------------------------|---|---|-------------------------|------|-----------------------|-------|
| | Input Load Current | In In | | | ±1 | μΑ |
| I _{LI} | Input Load Current | $V_{IN} = 0V \text{ to } V_{CC}$ | Auto. | | ±5 | μΑ |
| | Outrout Lookson Comment | \\ | Ind. | | ±5 | μΑ |
| I _{LO} | Output Leakage Current | $V_{OUT} = 0V \text{ to } V_{CC}$ | Auto. | | ±10 | μΑ |
| I _{PP1} ⁽²⁾ | V _{PP} ⁽¹⁾ Read/Standby Current | $V_{PP} = V_{CC}$ | | | 10 | μΑ |
| |)/ (1) Ota a alla a Occurrent | I_{SB1} (CMOS), $\overline{CE} = V_{CC} \pm 0.3V$ | | | 100 | μΑ |
| I _{SB} | V _{CC} ⁽¹⁾ Standby Current | I_{SB2} (TTL), \overline{CE} = 2.0 to V_{CC} + 0.5V | | | 1 | mA |
| I _{cc} | V _{CC} Active Current | f = 5 MHz, I _{OUT} = 0 mA | $\overline{E} = V_{IL}$ | | 20 | mA |
| V _{IL} | Input Low Voltage | | | -0.6 | 0.8 | V |
| V _{IH} | Input High Voltage | | | 2.0 | V _{CC} + 0.5 | V |
| V _{OL} | Output Low Voltage | I _{OL} = 2.1 mA | | | 0.4 | V |
| V _{OH} | Output High Voltage | I _{OH} = -400 μA | | 2.4 | | V |

Notes: 1. V_{CC} must be applied simultaneously with or before V_{PP} and removed simultaneously with or after V_{PP} .

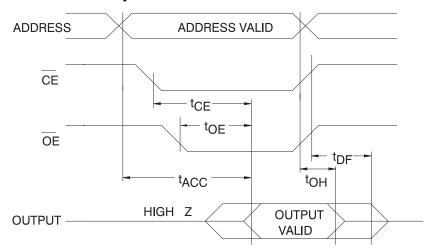
2. V_{PP} may be connected directly to V_{CC}, except during programming. The supply current would then be the sum of I_{CC} and I_{PP}

9. AC Characteristics for Read Operation

| | | | | AT27C256R | | | | |
|---------------------------------|---|----------------------|-----|-----------|-----|-----|-------|--|
| | | | - | 45 | -70 | | | |
| Symbol | Parameter | Condition | Min | Max | Min | Max | Units | |
| t _{ACC} ⁽¹⁾ | Address to Output Delay $\overline{CE} = \overline{OE} = V_{IL}$ | | | 45 | | 70 | ns | |
| t _{CE} ⁽¹⁾ | CE to Output Delay | OE = V _{IL} | | 45 | | 70 | ns | |
| t _{OE} ⁽¹⁾ | OE to Output Delay | CE = V _{IL} | | 20 | | 30 | ns | |
| t _{DF} ⁽¹⁾ | OE or CE High to Output Float, Whichever Occurred First | | | 20 | | 25 | ns | |
| t _{OH} | Output Hold from Address, \overline{CE} or \overline{OE} , Whichever Occurred First | | | | 7 | | ns | |

Note: 1. See AC Waveforms for Read Operation.

10. AC Waveforms for Read Operation(1)



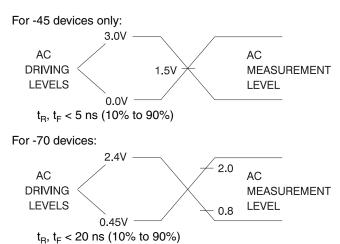
Notes: 1. Timing measurement reference level is 1.5V for -45 devices. Input AC drive levels are V_{IL} = 0.0V and V_{IH} = 3.0V. Timing measurement reference levels for all other speed grades are V_{OL} = 0.8V and V_{OH} = 2.0V. Input AC drive levels are V_{IL} = 0.45V and V_{IH} = 2.4V.

- 2. $\overline{\text{OE}}$ may be delayed up to t_{CE} t_{OE} after the falling edge of $\overline{\text{CE}}$ without impact on t_{CE} .
- 3. $\overline{\text{OE}}$ may be delayed up to t_{ACC} t_{OE} after the address is valid without impact on t_{ACC} .
- 4. This parameter is only sampled and is not 100% tested.
- 5. Output float is defined as the point when data is no longer driven.

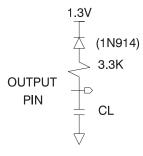




11. Input Test Waveforms and Measurement Levels



12. Output Test Load



Note: 1. $C_L = 100 \text{ pF}$ including jig capacitance, except for the -45 devices, where $C_L = 30 \text{ pF}$.

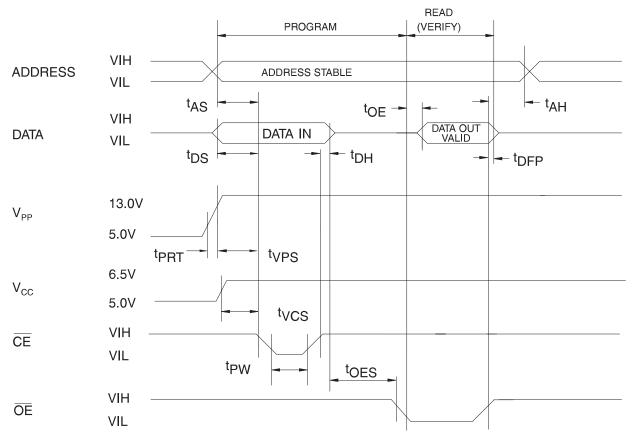
13. Pin Capacitance

 $f = 1 \text{ MHz}, T = 25^{\circ}C^{(1)}$

| Symbol | Тур | Max | Units | Conditions |
|------------------|-----|-----|-------|-----------------------|
| C _{IN} | 4 | 6 | pF | $V_{IN} = 0V$ |
| C _{OUT} | 8 | 12 | pF | V _{OUT} = 0V |

Note: 1. Typical values for nominal supply voltage. This parameter is only sampled and is not 100% tested.

14. Programming Waveforms⁽¹⁾



- Notes: 1. The Input Timing Reference is 0.8V for $V_{\rm IL}$ and 2.0V for $V_{\rm IH}$.
 - 2. t_{OE} and t_{DFP} are characteristics of the device but must be accommodated by the programmer.
 - 3. When programming the AT27C256R a 0.1 μF capacitor is required across V_{PP} and ground to suppress spurious voltage transients.

15. DC Programming Characteristics

 $T_A = 25 \pm 5^{\circ} C$, $V_{CC} = 6.5 \pm 0.25 V$, $V_{PP} = 13.0 \pm 0.25 V$

| | | | Limits | | |
|------------------|---|---------------------------|--------|---------------------|-------|
| Symbol | Parameter | Test Conditions | Min | Max | Units |
| ILI | Input Load Current | $V_{IN} = V_{IL}, V_{IH}$ | | ±10 | μΑ |
| V_{IL} | Input Low Level | | -0.6 | 0.8 | V |
| V_{IH} | Input High Level | | 2.0 | V _{CC} + 1 | V |
| V _{OL} | Output Low Volt | I _{OL} = 2.1 mA | | 0.4 | V |
| V _{OH} | Output High Volt | I _{OH} = -400 μA | 2.4 | | V |
| I _{CC2} | V _{CC} Supply Current (Program and Verify) | | | 25 | mA |
| I _{PP2} | V _{PP} Current | CE = V _{IL} | | 25 | mA |
| V _{ID} | A9 Product Identification Voltage | | 11.5 | 12.5 | V |



16. AC Programming Characteristics

 $T_A = 25 \pm 5^{\circ}C, \ V_{CC} = 6.5 \pm 0.25V, \ V_{PP} = 13.0 \pm 0.25V$

| | | | Lir | | |
|------------------|--|----------------------------------|-----|-----|-------|
| Symbol | Parameter | Test Conditions ⁽¹⁾ | Min | Max | Units |
| t _{AS} | Address Setup Time | | 2 | | μs |
| t _{OES} | OE Setup Time | Input Rise and Fall Times | 2 | | μs |
| t _{DS} | Data Setup Time | (10% to 90%) 20 ns | 2 | | μs |
| t _{AH} | Address Hold Time | Input Dulce Levels | 0 | | μs |
| t _{DH} | Data Hold Time | Input Pulse Levels 0.45V to 2.4V | 2 | | μs |
| t _{DFP} | OE High to Output Float Delay ⁽²⁾ | | 0 | 130 | ns |
| t _{VPS} | V _{PP} Setup Time | Input Timing Reference Level | 2 | | μs |
| t _{VCS} | V _{CC} Setup Time | 0.8V to 2.0V | 2 | | μs |
| t _{PW} | CE Program Pulse Width ⁽³⁾ | Output Timing Reference Level | 95 | 105 | μs |
| t _{OE} | Data Valid from $\overline{\text{OE}}^{(2)}$ | 0.8V to 2.0V | | 150 | ns |
| t _{PRT} | V _{PP} Pulse Rise Time During Programming | | 50 | | ns |

Notes: 1. V_{CC} must be applied simultaneously or before V_{PP} and removed simultaneously or after V_{PP}

17. Atmel's AT27C256R Integrated Product Identification Code

| | | Pins | | | | | Hex | | | |
|--------------|----|------|----|----|----|----|-----|----|----|------|
| Codes | A0 | 07 | O6 | O5 | 04 | О3 | O2 | 01 | 00 | Data |
| Manufacturer | 0 | 0 | 0 | 0 | 1 | 1 | 1 | 1 | 0 | 1E |
| Device Type | 1 | 1 | 0 | 0 | 0 | 1 | 1 | 0 | 0 | 8C |

^{2.} This parameter is only sampled and is not 100% tested. Output Float is defined as the point where data is no longer driven – see timing diagram.

^{3.} Program Pulse width tolerance is 100 $\,\mu sec \pm 5\%$.



19. Ordering Information

19.1 Standard Package

| t _{ACC} | I _{CC} (mA) | | | | |
|------------------|----------------------|---------|----------------|--------------------|--------------------|
| (ns) | Active | Standby | Ordering Code | Package | Operation Range |
| 45 | 20 | 0.1 | AT27C256R-45JI | 32J | Industrial |
| | | | AT27C256R-45PI | 28P6 | (-40° C to 85° C) |
| | | | AT27C256R-45RI | 28R ⁽¹⁾ | |
| | | | AT27C256R-45TI | 28T | |
| 70 | 20 | 0.1 | AT27C256R-70JI | 32J | Industrial |
| | | | AT27C256R-70PI | 28P6 | (-40° C to 85° C) |
| | | | AT27C256R-70RI | 28R ⁽¹⁾ | |
| | | | AT27C256R-70TI | 28T | |
| | 20 | 0.1 | AT27C256R-70JA | 32J | Automotive |
| | | | AT27C256R-70PA | 28P6 | (-40° C to 125° C) |
| | | | AT27C256R-70RA | 28R ⁽¹⁾ | |

Note:

Not recommended for new designs. Use Green package option.

19.2 Green Package (Pb/Halide-free)

| | | | - | | |
|------------------|----------------------|---------|----------------|--------------------|-------------------|
| t _{ACC} | I _{CC} (mA) | | | | |
| (ns) | Active | Standby | Ordering Code | Package | Operation Range |
| 45 | 20 | 0.1 | AT27C256R-45JU | 32J | Industrial |
| | | | AT27C256R-45PU | 28P6 | (-40° C to 85° C) |
| | | | AT27C256R-45RU | 28R ⁽¹⁾ | |
| | | | AT27C256R-45TU | 28T | |
| 70 | 20 | 0.1 | AT27C256R-70JU | 32J | Industrial |
| | | | AT27C256R-70PU | 28P6 | (-40° C to 85° C) |
| | | | AT27C256R-70RU | 28R ⁽¹⁾ | |
| | | | AT27C256R-70TU | 28T | |

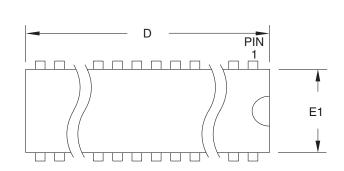
Note:

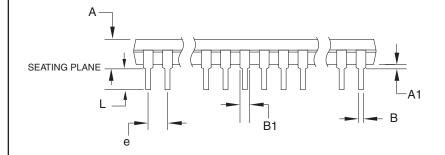
1. The 28-pin SOIC package is not recommended for new designs.

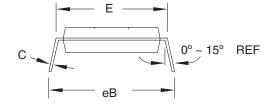
| | Package Type | | | | | |
|------|--|--|--|--|--|--|
| 32J | 32J 32-lead, Plastic J-Leaded Chip Carrier (PLCC) | | | | | |
| 28P6 | 28-lead, 0.600" Wide, Plastic Dual Inline Package (PDIP) | | | | | |
| 28R | 28-lead, 0.330" Wide, Plastic Gull Wing Small Outline (SOIC) | | | | | |
| 28T | 28-lead, Thin Small Outline Package (TSOP) | | | | | |



20.2 28P6 - PDIP







Notes:

- 1. This package conforms to JEDEC reference MS-011, Variation AB.
- Dimensions D and E1 do not include mold Flash or Protrusion. Mold Flash or Protrusion shall not exceed 0.25 mm (0.010").

COMMON DIMENSIONS

(Unit of Measure = mm)

| SYMBOL | MIN | NOM | MAX | NOTE |
|--------|-----------|-----|--------|--------|
| Α | ı | _ | 4.826 | |
| A1 | 0.381 | _ | ı | |
| D | 36.703 | _ | 37.338 | Note 2 |
| Е | 15.240 | _ | 15.875 | |
| E1 | 13.462 | _ | 13.970 | Note 2 |
| В | 0.356 | _ | 0.559 | |
| B1 | 1.041 | _ | 1.651 | |
| L | 3.048 | _ | 3.556 | |
| С | 0.203 | _ | 0.381 | |
| eB | 15.494 | _ | 17.526 | |
| е | 2.540 TYP | | | |

| 2325 (San Jo | ose, CA 95131 |
|------------------|---------------|
|------------------|---------------|

| TITLE |
|---|
| 28P6 , 28-lead (0.600"/15.24 mm Wide) Plastic Dual Inline Package (PDIP) |

| DRAWING NO. | REV. |
|-------------|------|
| 28P6 | В |